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Team Nexperia

16-bit bus transceiver with direction pin; 5 V tolerant; 3-stateRev. 12 — 13 February 2012Product data sheet

### 1. General description

The 74LVC16245A; 74LVCH16245A are 16-bit transceivers featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The device features two output enable  $(n\overline{OE})$  inputs for easy cascading and two send/receive (nDIR) inputs for direction control. nOE controls the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The 74LVCH16245A bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

### 2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance when V<sub>CC</sub> = 0 V
- All data inputs have bus hold (74LVCH16245A only)
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



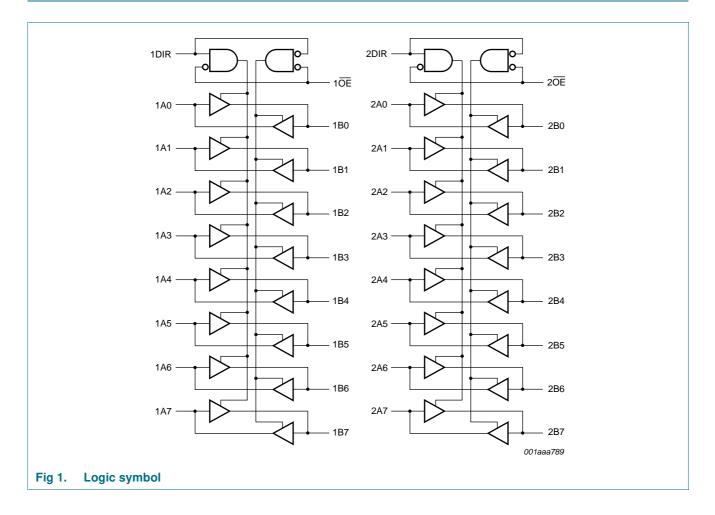
16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

## 3. Ordering information

Table 1.	Ordering information
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Type number	Temperature range			
		Name	Description	Version
74LVC16245ADL	–40 °C to +125 °C	SSOP48	plastic shrink small outline package; 48 leads;	SOT370-1
74LVCH16245ADL			body width 7.5 mm	
74LVC16245ADGG	–40 °C to +125 °C	TSSOP48	Provide and a second provide provide grade and gr	
74LVCH16245ADGG			48 leads; body width 6.1 mm	
74LVC16245AEV	–40 °C to +125 °C	VFBGA56	plastic very thin fine-pitch ball grid array package;	SOT702-1
74LVCH16245AEV			56 balls; body $4.5 \times 7 \times 0.65$ mm	
74LVC16245ABX	–40 °C to +125 °C	HXQFN60	plastic compatible thermal enhanced extremely	SOT1134-2
74LVCH16245ABX	-		thin quad flat package; no leads; 60 terminals; body $4 \times 6 \times 0.5$ mm	

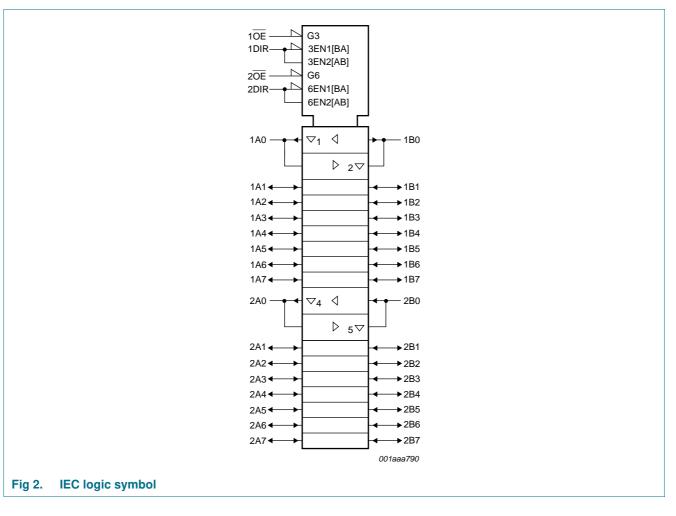
### 4. Functional diagram

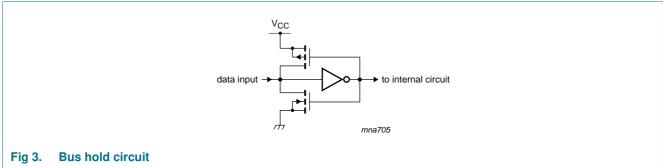


### **NXP Semiconductors**

## 74LVC16245A; 74LVCH16245A

### 16-bit bus transceiver with direction pin; 5 V tolerant; 3-state



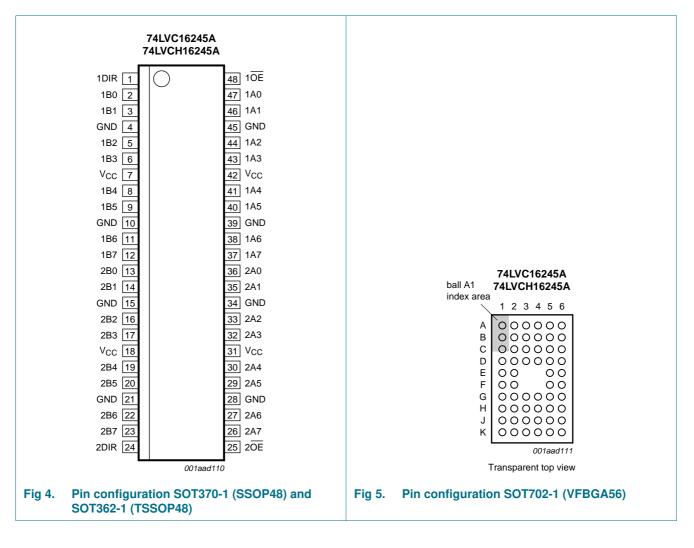


74LVC\_LVCH16245A

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

### 5. Pinning information

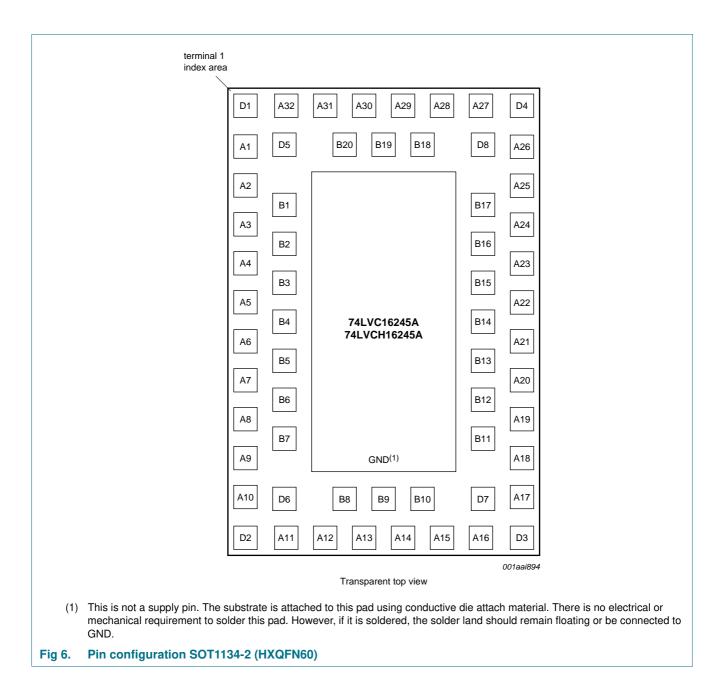
### 5.1 Pinning



### **NXP Semiconductors**

## 74LVC16245A; 74LVCH16245A

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state



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## 74LVC16245A; 74LVCH16245A

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

### 5.2 Pin description

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Symbol	Pin			Description
	SOT370-1 and SOT362-1	SOT702-1	SOT1134-2	-
1DIR, 2DIR	1, 24	A1, K1	A30, A13	direction control input
1B0 to 1B7	2, 3, 5, 6, 8, 9, 11, 12	B2, B1, C2, C1, D2, D1, E2, E1	B20, A31, D5, D1, A2, B2, B3, A5	data input/output
2B0 to 2B7	13, 14, 16, 17, 19, 20, 22, 23	F1, F2, G1, G2, H1, H2, J1, J2	A6, B5, B6, A9, D2, D6, A12, B8	data input/output
GND	4, 10, 15, 21, 28, 34, 39, 45	B3, B4, D3, D4, G3, G4, J3, J4	A32, A3, A8, A11, A16, A19, A24, A27	ground (0 V)
V <sub>CC</sub>	7, 18, 31, 42	C3, C4, H3, H4	A1, A10, A17, A26	supply voltage
1 <u>0E</u> , 2 <u>0E</u>	48, 25	A6, K6	A29, A14	output enable input (active LOW)
1A0 to 1A7	47, 46, 44, 43, 41, 40, 38, 37	B5, B6, C5, C6, D5, D6, E5, E6	B18, A28, D8, D4, A25, B16, B15, A22	data input/output
2A0 to 2A7	36, 35, 33, 32, 30, 29, 27, 26	F6, F5, G6, G5, H6, H5, J6, J5	A21, B13, B12, A18, D3, D7, A15, B10	data input/output
n.c.	-	A2, A3, A4, A5, K2, K3, K4, K5	A4, A7, A20, A23, B1, B4, B7, B9, B11, B14, B17, B19	not connected

## 6. Functional description

#### Table 3.Function table[1]

		Outputs		
nOE	nDIR	nAn	nBn	
L	L	nAn = nBn	inputs	
L	Н	inputs	nBn = nAn	
Н	Х	Z	Z	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	output HIGH or LOW	[2] -0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[2]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C;$			
		(T)SSOP48 package	<u>[3]</u>	500	mW
		VFBGA56 package	<u>[4]</u> _	1000	mW
		HXQFN60 package	<u>[4]</u> -	1000	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] Above 60 °C the value of  $P_{tot}$  derates linearly with 5.5 mW/K.

[4] Above 70 °C the value of  $P_{tot}$  derates linearly with 1.8 mW/K.

### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW	0	-	V <sub>CC</sub>	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC}$ = 1.2 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V
-						

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	–40 °C to	o +125 ℃	Uni
			Min	Typ[1]	Max	Min	Max	
V <sub>IH</sub>	HIGH-level input	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	voltage	$V_{CC} = 1.65 \text{ V}$ to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	voltage	$V_{CC} = 1.65 \text{ V}$ to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC}$ = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
/ <sub>ОН</sub>	HIGH-level	$V_I = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu\text{A};$ $V_{CC} = 1.65 \ \text{V} \text{ to } 3.6 \ \text{V}$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	۷
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
/ <sub>OL</sub>	LOW-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_{O}$ = 12 mA; $V_{CC}$ = 2.7 V	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current <sup>[2]</sup>	$V_I = 5.5 V \text{ or GND};$ $V_{CC} = 3.6 V$	-	±0.1	±5	-	±20	μA
OZ	OFF-state output current <sup>[2][3]</sup>		-	±0.1	±5	-	±20	μA
OFF	power-off leakage current	$V_{I} \text{ or } V_{O} = 5.5 \text{ V};  V_{CC} = 0.0 \text{ V}$	-	±0.1	±10	-	±20	μA
сс	supply current		-	0.1	20	-	80	μA
Alcc	additional supply current	per input pin; V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 2.7 V to 3.6 V	-	5	500	-	5000	μA
ો	input capacitance	$V_{CC} = 0 V$ to 3.6 V; V <sub>1</sub> = GND to V <sub>CC</sub>	-	5.0	-	-	-	рF
C <sub>I/O</sub>	input/output capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$	-	10	-	-	-	рF

74LVC\_LVCH16245A

#### 16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Symbol	Parameter	Conditions	-40	) °C to +85	5 °C	–40 °C to +125 °C		Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	-
I <sub>BHL</sub>	bus hold LOW	$V_{CC} = 1.65; V_{I} = 0.58 V$	10	-	-	10	-	μA
	current [4][5]	$V_{CC} = 2.3; V_I = 0.7 V$	30	-	-	25	-	μA
		$V_{CC} = 3.0; V_I = 0.8 V$	75	-	-	60	-	μA
I <sub>BHH</sub>	bus hold HIGH current [4][5]	$V_{CC} = 1.65; V_{I} = 1.07 V$	-10	-	-	-10	-	μA
		$V_{CC} = 2.3; V_I = 1.7 V$	-30	-	-	-25	-	μA
		$V_{CC} = 3.0; V_1 = 2.0 V$	-75	-	-	-60	-	μA
I <sub>BHLO</sub>	bus hold LOW	V <sub>CC</sub> = 1.95 V	200	-	-	200	-	μA
	overdrive current	V <sub>CC</sub> = 2.7 V	300	-	-	300	-	μA
	<u>(-)(-)</u>	V <sub>CC</sub> = 3.6 V	500	-	-	500	-	μA
I <sub>BHHO</sub>	bus hold HIGH	V <sub>CC</sub> = 1.95 V	-200	-	-	-200	-	μA
	overdrive current	V <sub>CC</sub> = 2.7 V	-300	-	-	-300	-	μA
	<u>1-11-1</u>	V <sub>CC</sub> = 3.6 V	-500	-	-	-500	-	μA

#### Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

[2] The bus hold circuit is switched off when  $V_I > V_{CC}$  allowing 5.5 V on the input terminal.

[3] For I/O ports the parameter  $I_{\text{OZ}}$  includes the input leakage current.

[4] Valid for data inputs of bus hold parts only (74LVCH16245A). Note that control inputs do not have a bus hold circuit.

[5] The specified sustaining current at the data input holds the input below the specified  $V_I$  level.

[6] The specified overdrive current at the data input forces the data input to the opposite input state.

### **10. Dynamic characteristics**

#### Table 7.Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions	<b>−40 °C to +85 °C</b>		5 °C	–40 °C to +125 °C		Unit
			Min	Typ <sup>[2]</sup>	Max	Min	Max	
t <sub>pd</sub>	propagation	nAn to nBn; nBn to nAn; see Figure 7						
	delay	V <sub>CC</sub> = 1.2 V	-	13.0	-	-	-	ns
	$V_{CC} = 1.65 \text{ V}$ to 1.95 V	1.5	5.2	12.2	1.5	13.8	ns	
		$V_{CC}$ = 2.3 V to 2.7 V	1.0	2.8	6.0	1.0	6.7	ns
		$V_{CC} = 2.7 V$	1.0	2.7	4.7	1.0	6.0	ns
		$V_{CC}$ = 3.0 V to 3.6 V	1.0	2.4	4.5	1.0	6.0	ns
t <sub>en</sub>	enable time	nOE to nAn, nBn; see Figure 8 [1]						
		V <sub>CC</sub> = 1.2 V	-	15.0	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.5	5.9	15.0	1.5	16.9	ns
		$V_{CC}$ = 2.3 V to 2.7 V	1.0	3.3	7.9	1.0	8.8	ns
		$V_{CC} = 2.7 V$	1.5	3.5	6.7	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.0	2.7	5.5	1.0	7.0	ns

#### 16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Symbol	Parameter	Conditions	–40 °C to +85 °C		5 °C	–40 °C to +125 °C		Unit	
				Min	Typ <sup>[2]</sup>	Max	Min	Max	
t <sub>dis</sub>	disable time	nOE to nAn, nBn; see Figure 8	[1]						
		V <sub>CC</sub> = 1.2 V		-	11.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		1.0	4.9	13.1	1.0	14.7	ns
	$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		0.5	2.7	7.1	0.5	7.9	ns	
		$V_{CC} = 2.7 V$		1.5	3.4	6.6	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.3	5.6	1.5	7.0	ns
C <sub>PD</sub>	power	per input; $V_I = GND$ to $V_{CC}$	[3]						
	dissipation capacitance	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		-	11.5	-	-	-	pF
	capacitance	$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		-	15.2	-	-	-	рF
		$V_{CC} = 3.0 \text{ V}$ to 3.6 V		-	18.5	-	-	-	pF

#### Table 7. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

[2] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

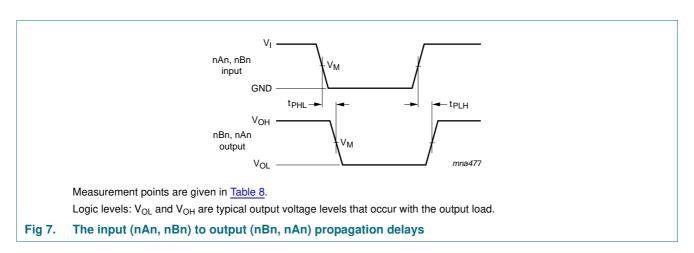
 $C_L$  = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

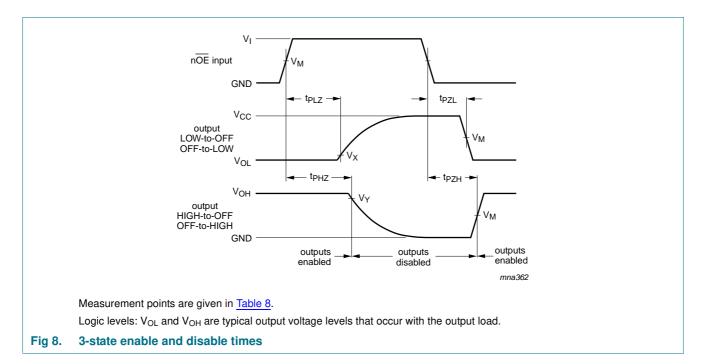
N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of the outputs.

### 11. Waveforms



16-bit bus transceiver with direction pin; 5 V tolerant; 3-state



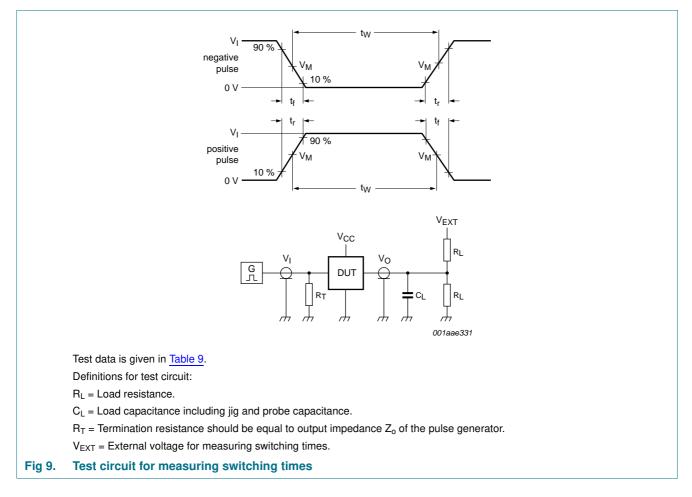
#### Table 8.Measurement points

Supply voltage	V <sub>M</sub>	Input						
V <sub>cc</sub>		VI	$t_r = t_f$	V <sub>X</sub>	V <sub>Y</sub>			
1.2 V	$0.5  imes V_{CC}$	V <sub>CC</sub>	$\leq$ 2.5 ns	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
1.65 V to 1.95 V	$0.5 \times V_{CC}$	V <sub>CC</sub>	$\leq$ 2.5 ns	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
2.3 V to 2.7 V	$0.5 \times V_{CC}$	V <sub>CC</sub>	$\leq$ 2.5 ns	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
2.7 V	1.5 V	2.7 V	$\leq$ 2.5 ns	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 \ V$			
3.0 V to 3.6 V	1.5 V	2.7 V	$\leq$ 2.5 ns	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 \ V$			

### **NXP Semiconductors**

## 74LVC16245A; 74LVCH16245A

#### 16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

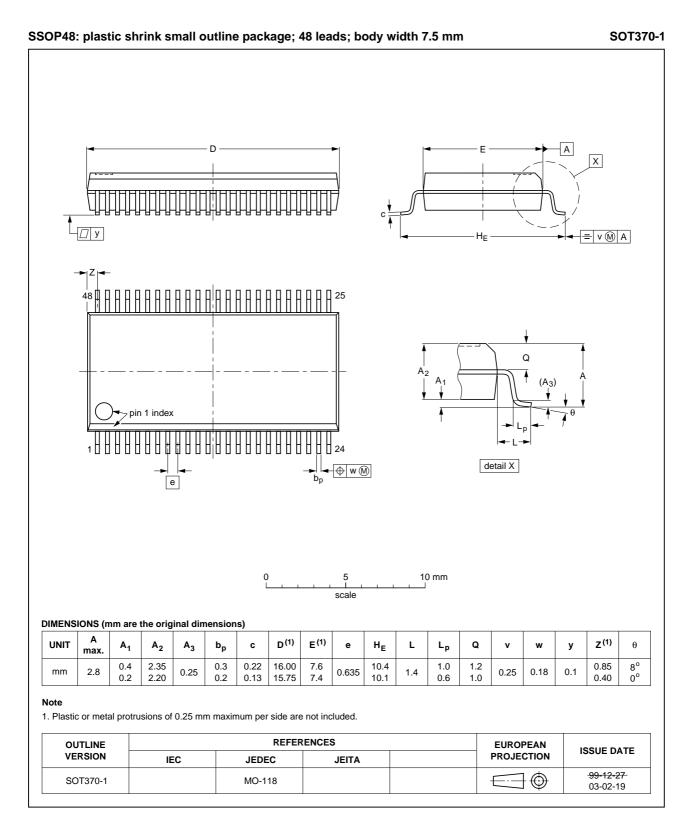


	Tab	le 9.	Test	data
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Supply voltage	Input		Load		V <sub>EXT</sub>	V <sub>EXT</sub>		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>	
1.2 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

## 12. Package outline

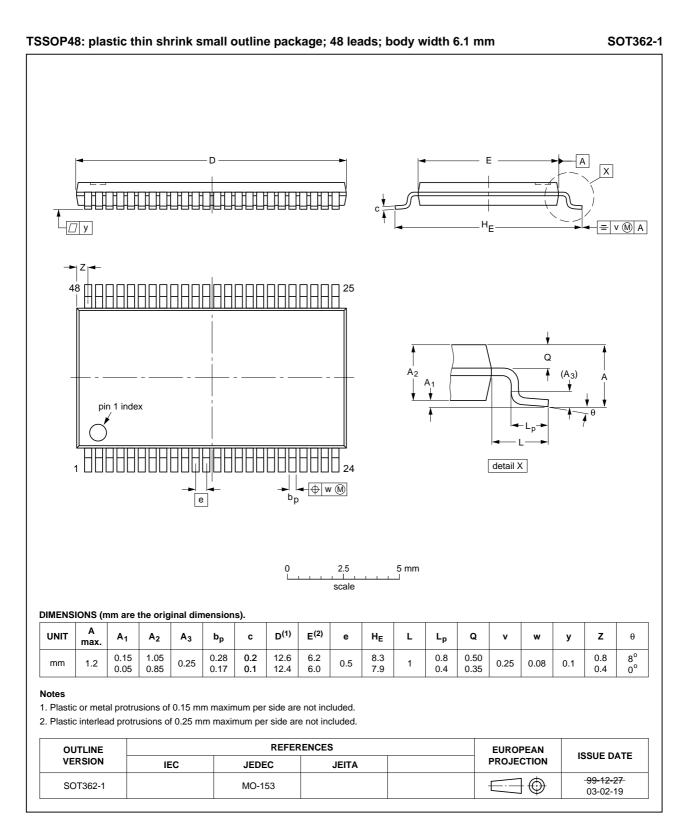


#### Fig 10. Package outline SOT370-1 (SSOP48)

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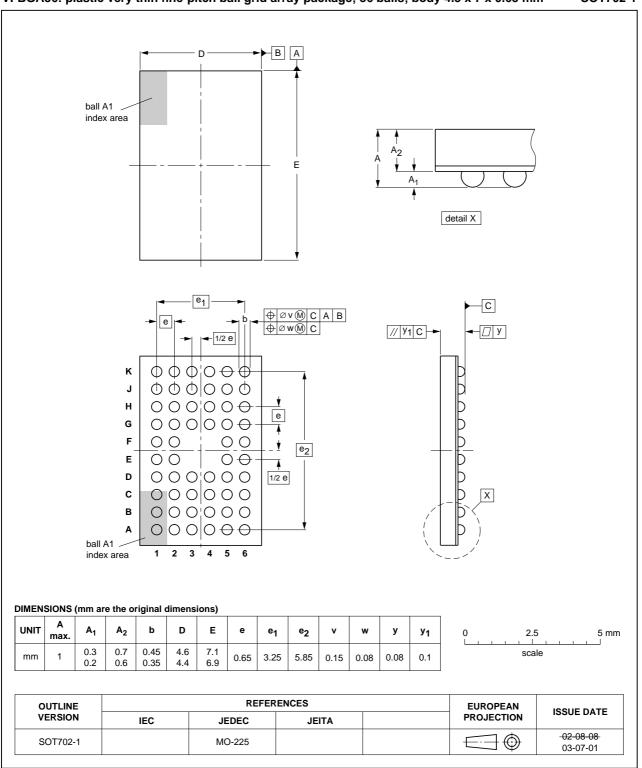


#### Fig 11. Package outline SOT362-1 (TSSOP48)

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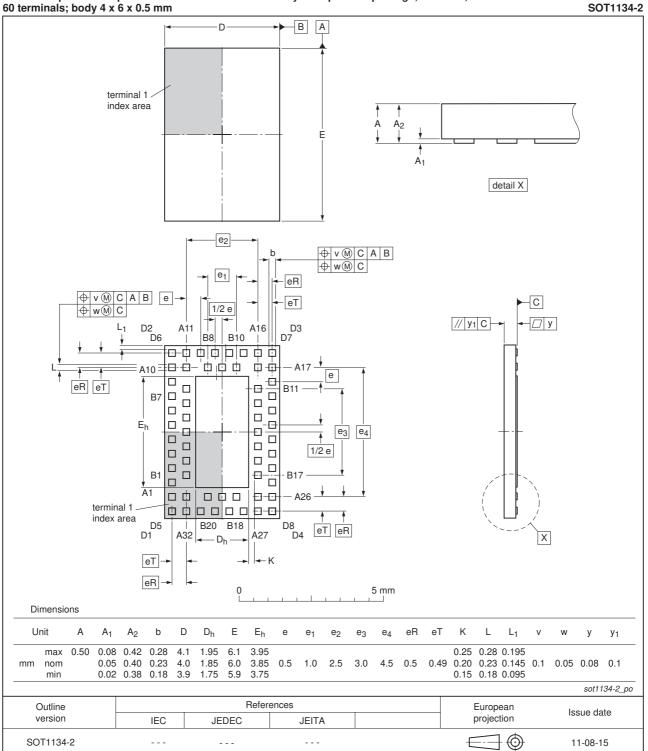
VFBGA56: plastic very thin fine-pitch ball grid array package; 56 balls; body 4.5 x 7 x 0.65 mm SOT702-1

#### Fig 12. Package outline SOT702-1 (VFBGA56)

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HXQFN60: plastic compatible thermal enhanced extremely thin quad flat package; no leads; 60 terminals; body 4 x 6 x 0.5 mm

#### Fig 13. Package outline SOT1134-2 (HXQFN60)

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## 13. Abbreviations

Table 10. Abbreviations		
Acronym	Description	
CDM	Charged Device Model	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	
TTL	Transistor-Transistor Logic	

## 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH16245A v.12	20120213	Product data sheet	-	74LVC_LVCH16245A v.11
Modifications:	<ul> <li>For type num SOT1134-2.</li> </ul>	ber 74LVC16245ABX and	3 74LVCH16245ABX	the sot code has changed to
74LVC_LVCH16245A v.11	20111208	Product data sheet	-	74LVC_LVCH16245A v.10
Modifications:	• Table 4, Table	<u>e 5, Table 6, Table 7, and</u>	Table 9: values adde	d for lower voltage ranges.
74LVC_LVCH16245A v.10	20110623	Product data sheet	-	74LVC_LVCH16245A v.9
Modifications:	<ul> <li>type numbers and 74LVCH<sup>-</sup></li> </ul>		4LVCH16245ABQ ch	nanged to 74LVC16245ABX
	<ul> <li>Figure 6: figu</li> </ul>	re note 1 changed.		
74LVC_LVCH16245A v.9	20100329	Product data sheet	-	74LVC_LVCH16245A v.8
74LVC_LVCH16245A v.8	20081106	Product data sheet	-	74LVC_LVCH16245A v.7
74LVC_LVCH16245A v.7	20031125	Product specification	-	74LVC_LVCH16245A v.6
74LVC_LVCH16245A v.6	20030130	Product specification	-	74LVC_LVCH16245A v.5
74LVC_LVCH16245A v.5	20021030	Product specification	-	74LVC_H16245A v.4
74LVC_H16245A v.4	19970925	Product specification	-	74LVC16245A_ 74LVCH16245A v.3
74LVC16245A_ 74LVCH16245A v.3	19970925	Product specification	-	74LVC16245A v.2
74LVC16245A v.2	19970801	Product specification	-	74LVC16245A v.1
74LVC16245A v.1	-	-	-	-

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[2] The term 'short data sheet' is explained in section "Definitions".

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